## ILLINOIS SOCIETY OF PROFESSIONAL ENGINEERS ST. CLAIR CHAPTER SCHOLARSHIP APPLICATION

PERSONAL INFOR	RMATION:			
Name:	ast		First	Middle
Home Address:			Number/Street	
_		С	ity/State/Zip Code	
Phone No.:		Em	ail:	
Date of Birth:				
ACADEMIC INFOR	RMATION:			
High School:				
Phone No.:				
Accumulative Grade	e Point Avera			
		3.0 or hig	her based on 4.0	
SAT/ACT Scores:	SAT	Math	Verbal (Min. Math 665	i; Min. Verbal 600)
	ACT	Math	English (Min. Math 29	; Min. English 25)
NOTE TO APPLICA				
Illinois or Missour of the Accreditation	i university/ca Board for En disqualified	ollege that has gineering and if the school is	been accredited by the Errechnology (EAC-ABET).	attend an engineering program at an agineering Accreditation Commission  Please rank the schools to indicate
Schools Applied to:			Date Applied:	Accepted (Yes/No):
1 <sup>st</sup> Choice:				
2 <sup>nd</sup> Choice:				
3 <sup>rd</sup> Choice:				
4 <sup>th</sup> Choice:				
Field of Engineering	g to be studie	d:		

Applicant Name:		
TECHNICAL SCHO	OL ACTIVITIES:	
List technical school science fair, WYSE,		s. Examples are: math club, science club, computer club,
Month/Year to Month/Year (most recent first)	<u>Activity</u>	Most Significant Contribution
NON-TECHNICAL S	SCHOOL ACTIVITIES:	
	chool activities and member nember, band, cheerleader,	ships. Examples are: school newspaper, yearbook, debate etc.
Month/Year to Month/Year (most recent first)	<u>Activity</u>	Most Significant Contribution
MAJOR OFFICES /	SIGNIFICANT CONTRIBU	TION TO HS ACTIVITIES:
	chool activities and member ss, student council or club,	rships. Examples are: president, vice-president, secretary, captain of sports team, etc.
Month/Year to Month/Year (most recent first)	<u>Activity</u>	Most Significant Contribution

Applicant Name:					
VOLUNTEER ACTIV	/ITIES:				
List on/off school vol Boy/Girl Scouts, 4-H			hips. Examples	are: camp counselor, Big Brother/Si	ster,
Month/Year to Month/Year (most recent first)	<u>Activity</u>		Most Significar	nt Contribution	_
					_
WORK EXPERIENC	E:				
List employment duri	ng school and sur	nmer break.			
Month/Year to Month/Year (most recent first)	Place of Employ Name of Supervi <u>Tel. No.</u>		Job Duties & h	ours worked per week	
					_
					_
HONORS AND AWA	ARDS:				
May or may not be a  Month/Year Spons		Name of A	<u>Award</u>	Reason for Receipt of Award	_
					_

Fees         6         8         8         8         9         9         9         9         9         100%           Supplies         School Year Living         \$         %         %         %         %         %         %         %         =100%	Item	plan to finance Estimated Cost	Savings	Grants	Scholarships	Family Support	Loans you legally ob to repay	oligated
Supplies School \$ % % % % % % % =100% Year Living Expenses Please provide your family's gross annual income for the past year. To you or your family have any financial hardships that the ISPE St. Clair Chapter Scholarship	Tuition/ Fees	\$	%	%	%	%	%	=100%
School \$ % % % % % % =100% Year Living Expenses Please provide your family's gross annual income for the past year.  To you or your family have any financial hardships that the ISPE St. Clair Chapter Scholarship	Books/ Supplies	\$	%	%	%	%	%	=100%
o you or your family have any financial hardships that the ISPE St. Clair Chapter Scholarship	School Year	\$	%	%	%	%	%	=100%
	Expenses	ide vour family	y's aross o	onual incon	ne for the pact y	/ear		
	o you or you	ur family have a	any financial	l hardships t	hat the ISPE St.		ter Scholars	ship

## **ESSAY:**

If necessary, use an additional sheet.

The essay should discuss your interest in engineering, your major area of study including your area of specialization, and the occupation you propose to pursue after graduation. What are your long-term goals and how do you hope to achieve them? The essay may also include any other pertinent information that is relevant to your career plans. The essay should be no more than 500 words in length, double-spaced, typewritten or computer printed. Put your name and major field of engineering at the top of the page.

Applicant Name:	
REQUIRED INFORMATION (SIGNATURES) Applications without signatures noted as require	ed will be disqualified.
Scholarship Applicant (Signature Required):	
Permission to Release or Validate Information	
According to the Family Educational Rights and Privacy cannot be released to a third party without the written copies of your transcript along with your scholarship as sign the following permission statement.	onsent of the student. So that we may distribute
I hereby grant permission to allow ISPE St. Cla contained in this application, including copies of ISPE St. Clair Chapter Scholarship Committee	of my transcript, to members of the
Also by signing this application, you agree that to the be on this application is complete and true.	est of your knowledge, the information presented
Applicant's Signature	Date
Principal/Guidance Counselor Certification (Sign	nature Required):
I certify that the academic information presented on the applicant meets the stated eligibility requirement	
I certify that the applicant is a U. S. citizen.	
Signature:	Date:
Printed Name and Title:	
High School:	
Phone Number:	
Assemble the application in the following order; do not  1. Application 2. Recommendation of Teacher (at least two)	use a report binder:

- 3. Employer Recommendation (optional)
- 4. Essay (maximum 500 words)
- 5. Official Transcripts (must be in a sealed envelope)
- 6. SAT/ACT Scores (SAT Math: 665, Verbal: 600) (ACT Math: 29, English: 25) (Attach One Official Score Sheet if not included on the official transcripts)

It is the responsibility of the applicant to see that complete information is submitted as required. Incomplete applications may not be considered. It is recommended that the applicant type the application. The overall appearance of the application is included in the scoring.

Interested students should submit the application package prior to March 28<sup>th</sup> of the current year. The application package shall be postmarked or hand delivered by this date. Forward complete application package to:

Mr. Matt Fields ISPE Scholarship Committee Chairman Wilson & Company, Inc. 3636 S. Geyer Road Suite 100 St. Louis, MO 63127

pplicant Name:	required for submittal with application):	
would recommend the above student for asons:	for an ISPE St. Clair Chapter scholarship for the followin	g
eacher's Name:	Date:	

	t required to be submitted):
vould recommend the above student for an ISPE asons:	St. Clair Chapter scholarship for the following
ame of Person Completing Recommendation:	
ame of Company and Position Held:	